

MAIL STOP AF
PATENT
8007-1116

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Takashi SUEYOSHI et al. Conf. 1846

Application No. 10/594,221 Group 1796

Filed September 25, 2006 Examiner R. Loewe

SILICON-CONTAINING CURING COMPOSITION AND HEAT CURED
PRODUCT THEREOF

AMENDMENT

Assistant Commissioner for Patents January 4, 2011
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Official Action mailed June 3, 2010,
further to Amendment After Final Rejection filed September 1,
2010, for which an Advisory Action was mailed September 10, 2010,
and the Request for Continued Examination and the Three-Month
Suspension of Action filed October 4, 2010, please amend the
above-identified application as follows:

Amendments to the Claims are reflected in the listing
of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.